

Symbol	Parameter		Ratings	Units	
V _{DSS}	Drain-to-Source Voltage		80	V	
V _{GS}	Gate-to-Source Voltage		±20	V	
I _D	Drain Current - Continuous (V _{GS} =10) (Note 1)	T _C =25°C	110	Α	
	Pulsed Drain Current	T _C = 25°C	See Figure 4		
E _{AS}	Single Pulse Avalanche Energy	(Note 2)	512	mJ	
D	Power Dissipation		300	W	
PD	Derate Above 25°C		2.0	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature		-55 to + 175	°C	
$R_{\theta JC}$	Thermal Resistance, Junction to Case		0.5	°C/W	
R _{0JA}	Maximum Thermal Resistance, Junction to Ambient	(Note 3)	43	°C/W	

Notes:

1: Current is limited by bondwire configuration.

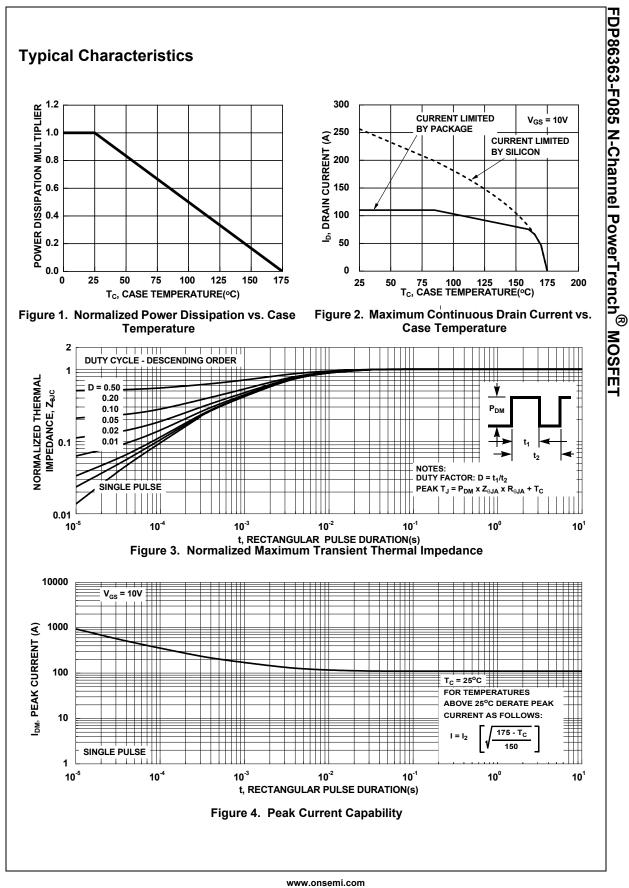
2: Starting $T_J = 25^{\circ}$ C, L = 0.25mH, $I_{AS} = 64A$, $V_{DD} = 80V$ during inductor charging and $V_{DD} = 0V$ during time in avalanche.

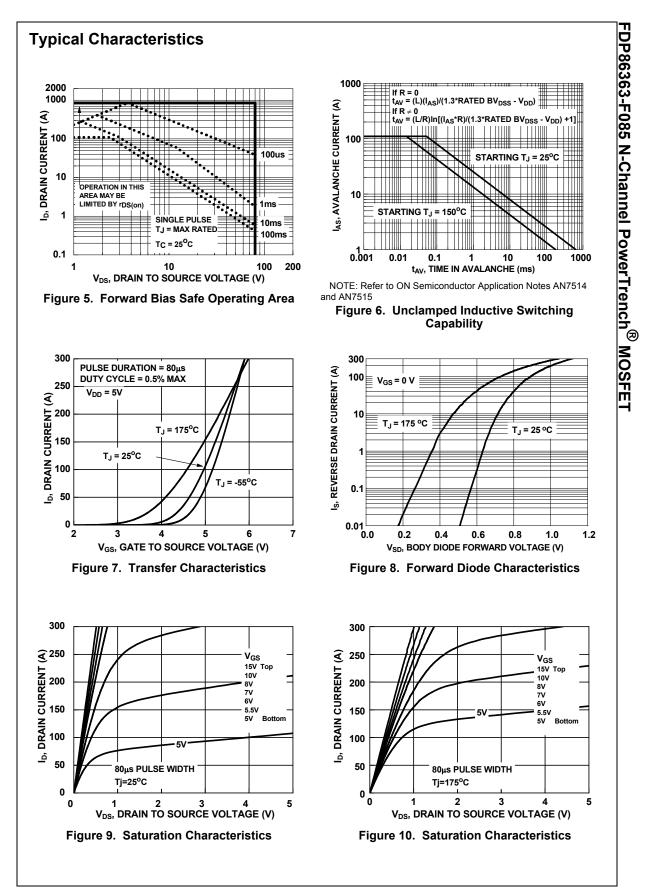
3: R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design, while R_{0JA} is determined by the board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2oz copper.

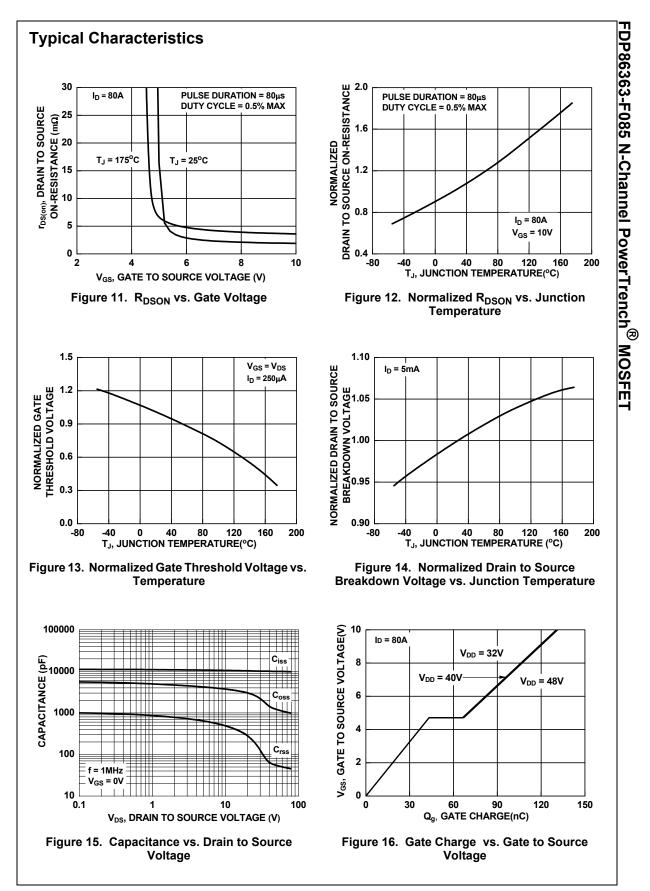
Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDP86363	FDP86363-F085	TO220AB	Tube	N/A	50 units

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Units
Off Cha	racteristics	İ.					
B _{VDSS}	Drain-to-Source Breakdown Voltage	I _D = 250μA, V _{GS} = 0V		80	-	-	V
	Drain to Course Lookana Current	V_{DS} =80V, T_{J} =25°C		-	-	1	μA
IDSS	Drain-to-Source Leakage Current	$V_{GS} = 0V$	$T_{\rm J}$ = 175°C (Note 4)	-	-	1	mA
I _{GSS}	Gate-to-Source Leakage Current	$V_{GS} = \pm 20V$		-	-	±100	nA
On Cha	racteristics						
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I	_D = 250μA	2.0	3.0	4.0	V
		I _D = 80A,	$T_{\rm J} = 25^{\rm o} {\rm C}$	-	2.4	2.8	mΩ
R _{DS(on)}	Drain to Source On Resistance	V _{GS} = 10V	T _J = 175 ^o C (Note 4)	-	3.8	4.3	mΩ
Dynami	ic Characteristics						
C _{iss}	Input Capacitance	$V_{DS} = 40V, V_{GS} = 0V,$ f = 1MHz f = 1MHz $V_{GS} = 0 \text{ to } 10V$ $V_{DD} = 64V$		-	10000	-	pF
C _{oss}	Output Capacitance			-	1400	-	pF
C _{rss}	Reverse Transfer Capacitance			-	95	-	pF
R _g	Gate Resistance			-	3.3	-	Ω
Q _{g(ToT)}	Total Gate Charge at 10V			-	131	150	nC
Q _{g(th)}	Threshold Gate Charge	$V_{GS} = 0$ to 2	V I _D = 80A	-	18	21	nC
Q _{gs}	Gate-to-Source Gate Charge			-	47	-	nC
Q _{gd}	Gate-to-Drain "Miller" Charge			-	24	-	nC
Switchi	ng Characteristics						
t _{on}	Turn-On Time			-	-	231	ns
t _{d(on)}	Turn-On Delay		t	-	38	-	ns
t _r	Rise Time	$V_{DD} = 40V, I_D = 80A,$ $V_{GS} = 10V, R_{GEN} = 6\Omega$		-	129	-	ns
t _{d(off)}	Turn-Off Delay			-	64	-	ns
t _f	Fall Time		t	-	40	-	ns
t _{off}	Turn-Off Time			-	-	135	ns
Drain-S	ource Diode Characteristics						
	Source-to-Drain Diode Voltage	I _{SD} =80A, V _{GS} = 0V		-	-	1.25	V
Vap	Source-to-Drain Diode Voltage	I _{SD} = 40A, ∨	/ _{GS} = 0V	-	-	1.2	V
V _{SD}		$I_{\rm F}$ = 80A, $dI_{\rm SD}/dt$ = 100A/µs,		-	88	101	ns
V _{SD}	Reverse-Recovery Time	I _F = 80A, dl V _{DD} =64V	$SD/ut = 100A/\mu S$,				







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